

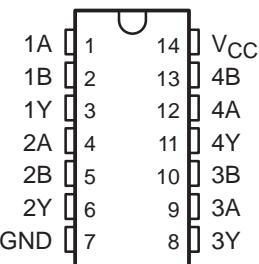
- Driver Version of 'AS08
- Offers High Capacitive-Drive Capability
- Package Options Include Plastic Small-Outline (D) Packages and Standard Plastic (N) 300-mil DIPs

description

This device contains four independent 2-input positive-AND buffers/drivers. It performs the Boolean functions $Y = A \bullet B$ or $Y = \bar{A} + \bar{B}$ in positive logic.

The SN74AS1008A is characterized for operation from 0°C to 70°C.

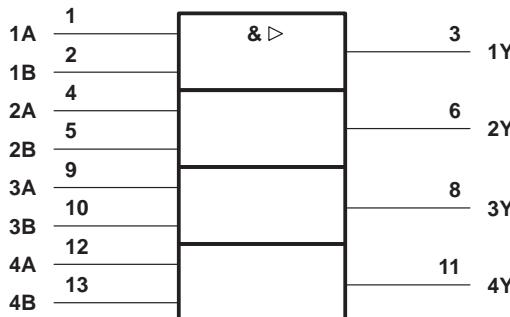
D OR N PACKAGE
(TOP VIEW)



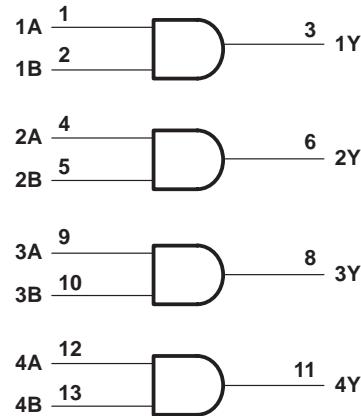
FUNCTION TABLE
(each gate)

| INPUTS | | OUTPUT |
|--------|---|--------|
| A | B | Y |
| H | H | H |
| L | X | L |
| X | L | L |

logic symbol†



logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| | |
|---|----------------|
| Supply voltage, V_{CC} | 7 V |
| Input voltage, V_I | 7 V |
| Operating free-air temperature range, T_A | 0°C to 70°C |
| Storage temperature range | -65°C to 150°C |

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

SN74AS1008A

QUADRUPLE 2-INPUT POSITIVE-AND BUFFER/DRIVER

SDAS071B – DECEMBER 1982 – REVISED JANUARY 1995

recommended operating conditions†

| | | MIN | NOM | MAX | UNIT |
|----------|--------------------------------|-----|-----|-----|------|
| V_{CC} | Supply voltage | 4.5 | 5 | 5.5 | V |
| V_{IH} | High-level input voltage | | 2 | | V |
| V_{IL} | Low-level input voltage | | | 0.8 | V |
| I_{OH} | High-level output current | | | -48 | mA |
| I_{OL} | Low-level output current | | | 48 | mA |
| T_A | Operating free-air temperature | 0 | | 70 | °C |

† This high sink- or source-current device is not recommended for use above 40 MHz.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | | MIN | TYP‡ | MAX | UNIT | |
|-----------|----------------------------|-------------------|--------------|------|------|------|--|
| | $V_{CC} = 4.5$ V, | $I_I = -18$ mA | | | | | |
| V_{OH} | $V_{CC} = 4.5$ V to 5.5 V, | $I_{OH} = -2$ mA | $V_{CC} - 2$ | | 2.4 | 3.2 | |
| | $V_{CC} = 4.5$ V | $I_{OH} = -3$ mA | | | | | |
| | | $I_{OH} = -48$ mA | | | 2 | | |
| V_{OL} | $V_{CC} = 4.5$ V, | $I_{OL} = 48$ mA | 0.35 | 0.5 | | V | |
| I_I | $V_{CC} = 5.5$ V, | $V_I = 7$ V | | 0.1 | | mA | |
| I_{IH} | $V_{CC} = 5.5$ V, | $V_I = 2.7$ V | | | 20 | µA | |
| I_{IL} | $V_{CC} = 5.5$ V, | $V_I = 0.4$ V | | | -0.5 | mA | |
| $I_O\$$ | $V_{CC} = 5.5$ V, | $V_O = 2.25$ V | -50 | | -200 | mA | |
| I_{CCH} | $V_{CC} = 5.5$ V, | $V_I = 4.5$ V | | 5.6 | 9.5 | mA | |
| I_{CCL} | $V_{CC} = 5.5$ V, | $V_I = 0$ | 13.5 | | 22 | mA | |

‡ All typical values are at $V_{CC} = 5$ V, $T_A = 25^\circ\text{C}$.

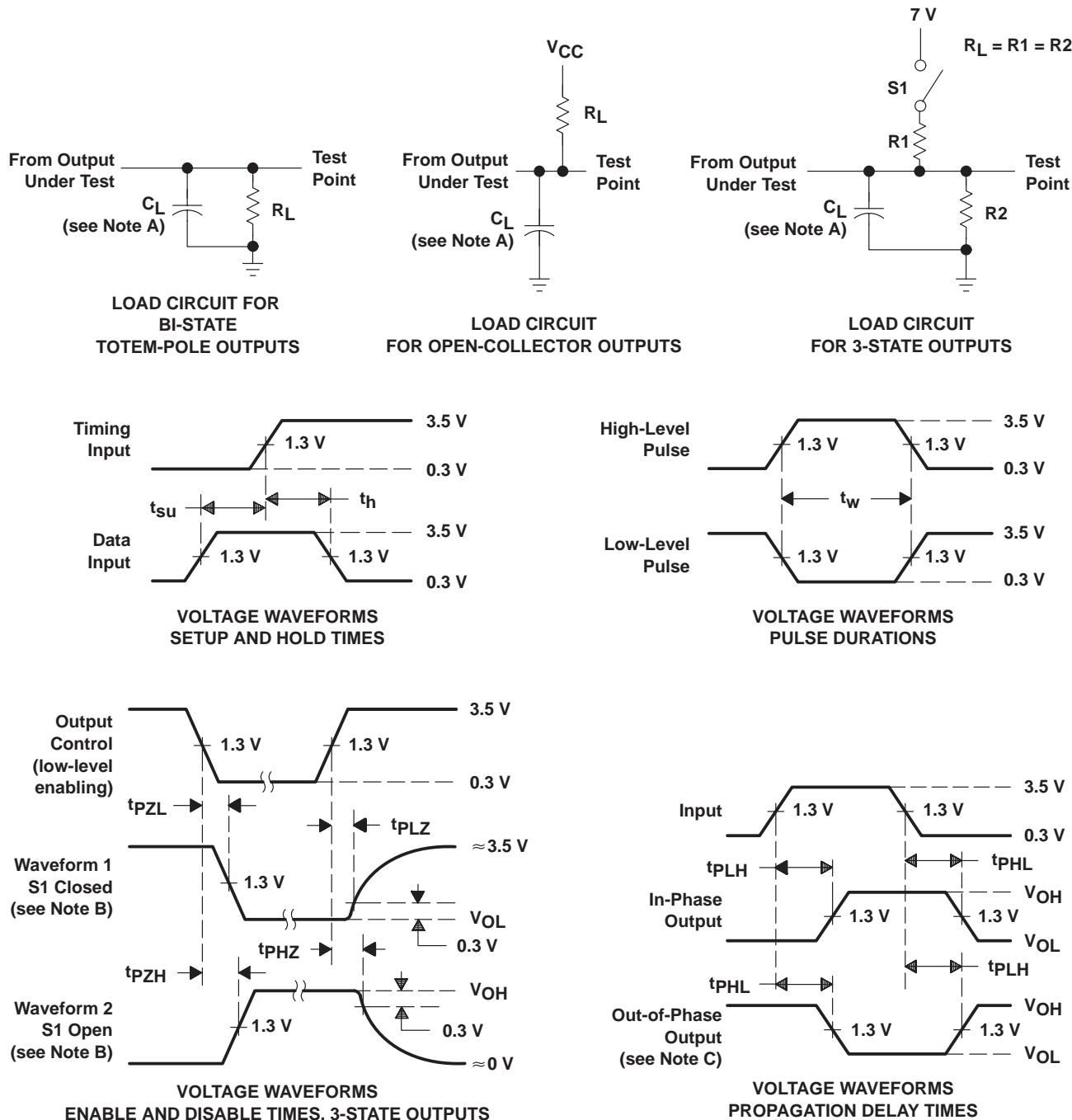
§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .

switching characteristics (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 4.5$ V to 5.5 V, $C_L = 50$ pF, $R_L = 500$ Ω, $T_A = \text{MIN to MAX}^\dagger$ | | UNIT |
|-----------|-----------------|----------------|---|-----|------|
| | | | MIN | MAX | |
| t_{PLH} | A or B | Y | 1 | 6 | ns |
| | | | 1 | 6 | |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

PARAMETER MEASUREMENT INFORMATION
SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 D. All input pulses have the following characteristics: $PRR \leq 1 \text{ MHz}$, $t_r = t_f = 2 \text{ ns}$, duty cycle = 50%.
 E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms

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PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|------------------|------------------------------|
| SN74AS1008AD | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS1008ADE4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS1008ADG4 | ACTIVE | SOIC | D | 14 | 50 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AS1008AN | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| SN74AS1008ANE4 | ACTIVE | PDIP | N | 14 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

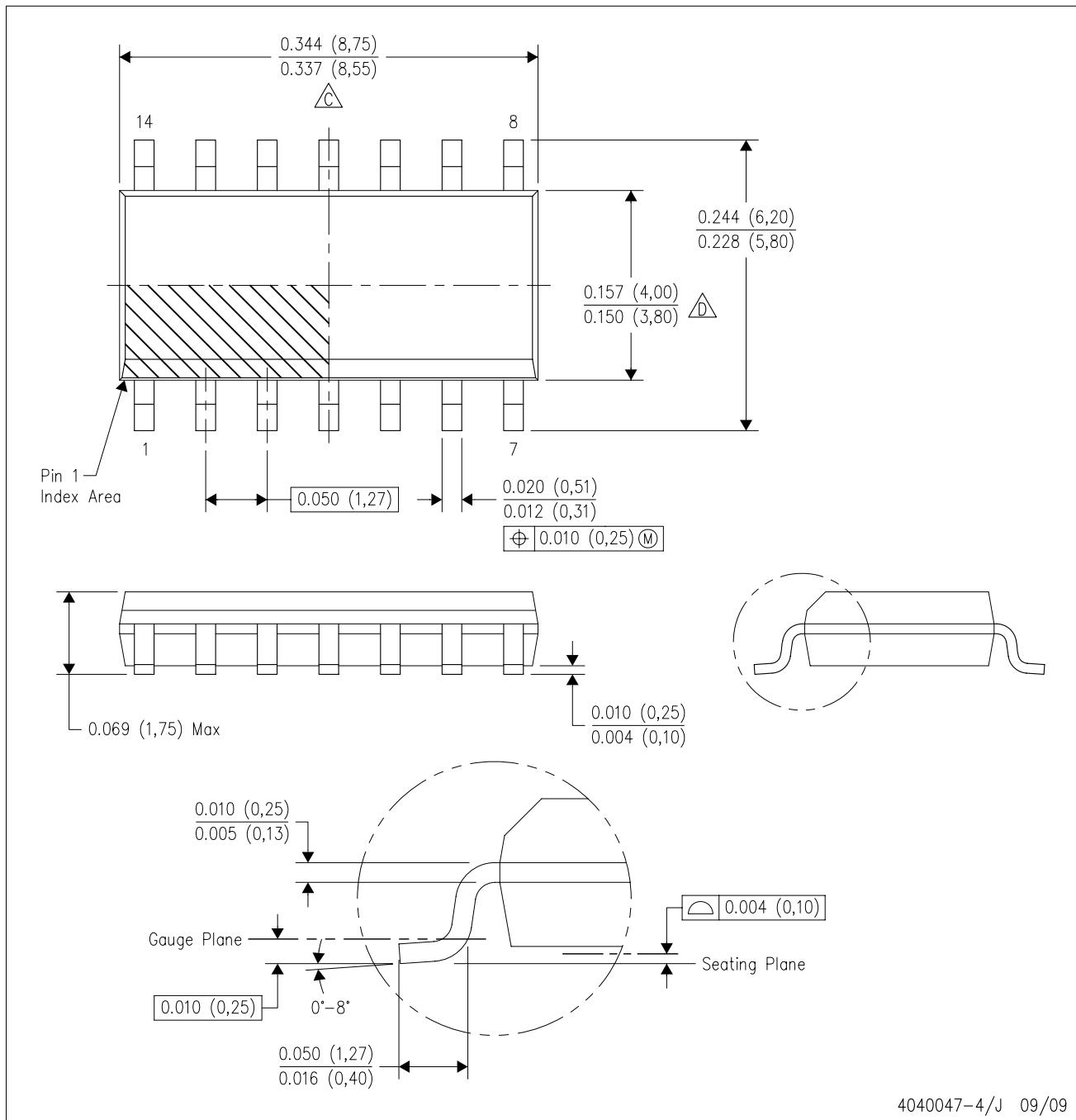
⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

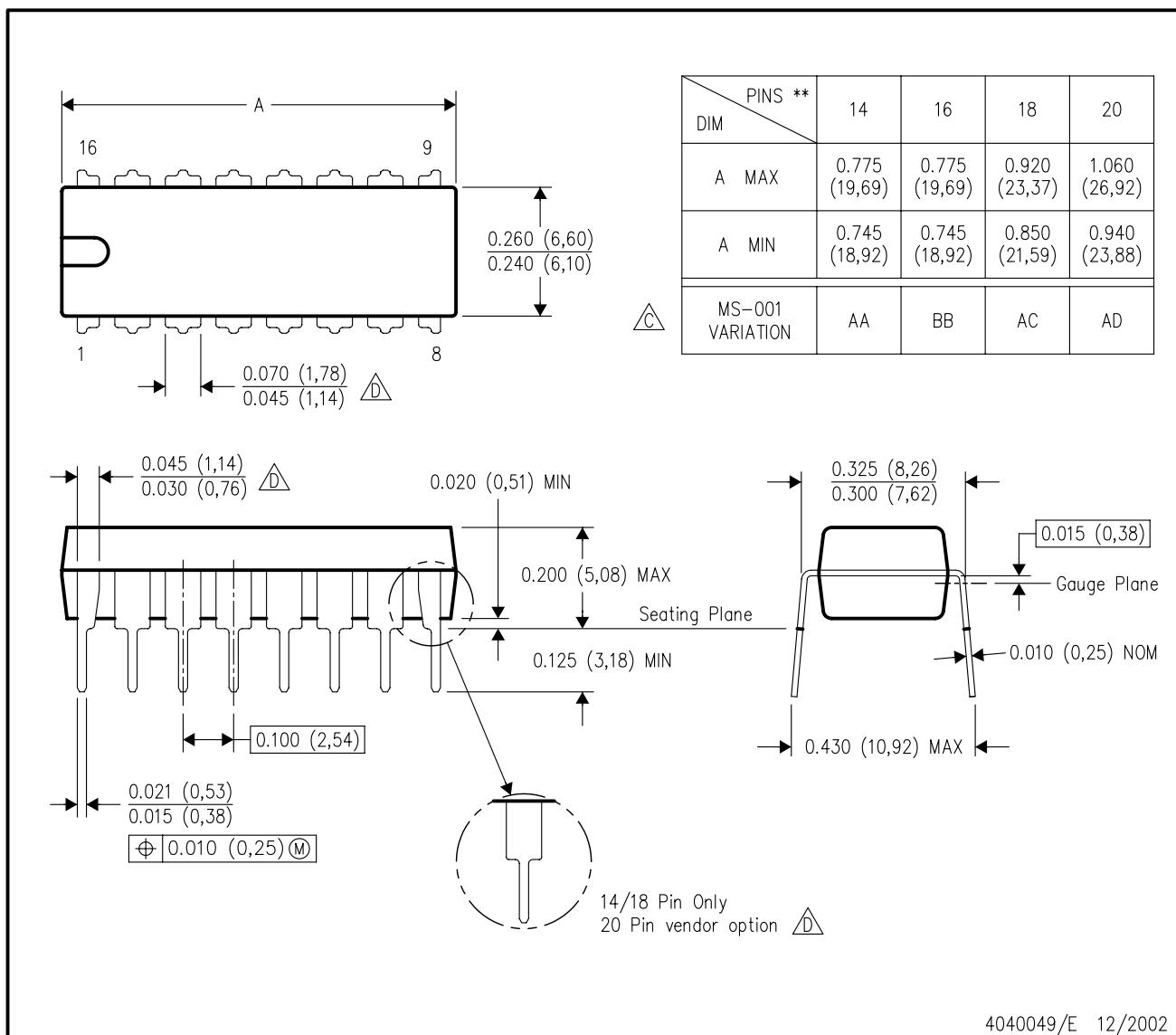
D. Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AB.

N (R-PDIP-T**)

16 PINS SHOWN

PLASTIC DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).
 B. This drawing is subject to change without notice.

C. Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).

D. The 20 pin end lead shoulder width is a vendor option, either half or full width.